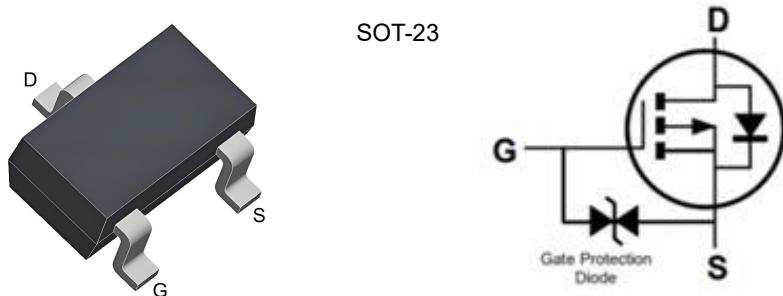


## P-Channel 20V(D-S) MOSFET

Product summary			Features
$V_{DS}$	-20	V	<ul style="list-style-type: none"> <li>Low Input Capacitance</li> <li>Fast Switching Speed</li> <li>ESD protection up to 2 kV</li> </ul>
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$ ) Typ.	560	$m\Omega$	Applications
$R_{DS(ON)}$ (at $V_{GS}=-2.5V$ ) Typ.	830	$m\Omega$	<ul style="list-style-type: none"> <li>Load Switching</li> <li>Logic Level Shift</li> </ul>
$I_D(T_A=25^\circ C)$	-0.5	A	

### Pin Configuration



### Packing Information

Device	Package	Reel Size	Quantity(Min. Package)
ECDA1013E	SOT-23	7"	3000pcs

### Absolute Maximum Ratings (at $T_A=25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-20	V
$V_{GS}$	Gate-Source Voltage	$\pm 10$	V
$I_D$	Continuous Drain Current at $V_{GS}=10V$ <sup>A</sup>	$T_A=25^\circ C$	A
		$T_A=70^\circ C$	A
$I_{DM}$	Pulse Drain Current Tested <sup>B</sup>	-2.3	A
$P_D$	Power Dissipation <sup>A</sup>	$T_A=25^\circ C$	W
$T_J, T_{STG}$	Junction and Storage Temperature Range	-55 to +150	°C

### Thermal Characteristics

Symbol	Parameter	Typical	Units
$R_{\theta JA}$	Thermal Resistance-Junction to ambient <sup>A</sup>	390	°C/W

Electrical Characteristics (at  $T_J = 25^\circ\text{C}$  Unless Otherwise Noted)

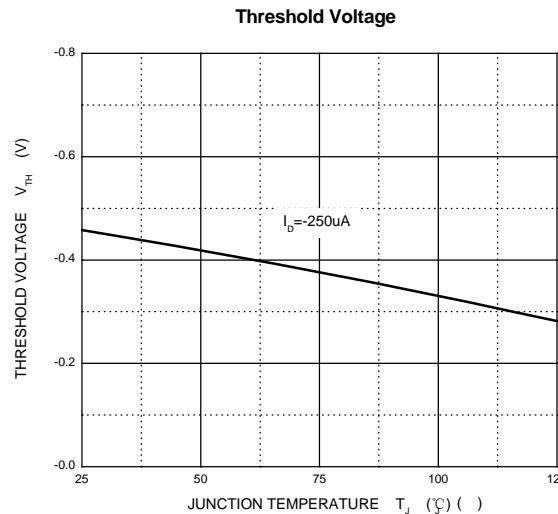
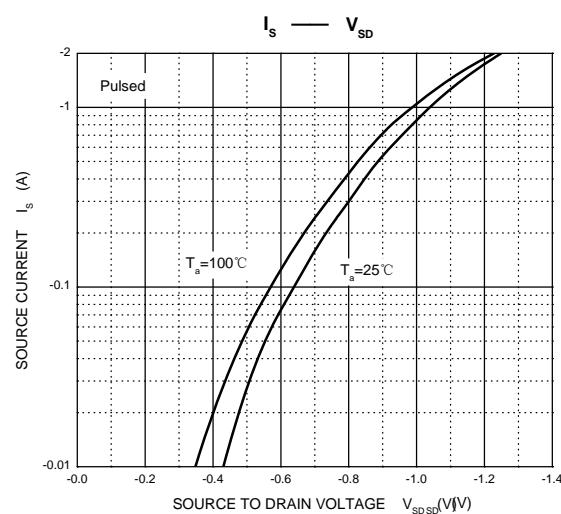
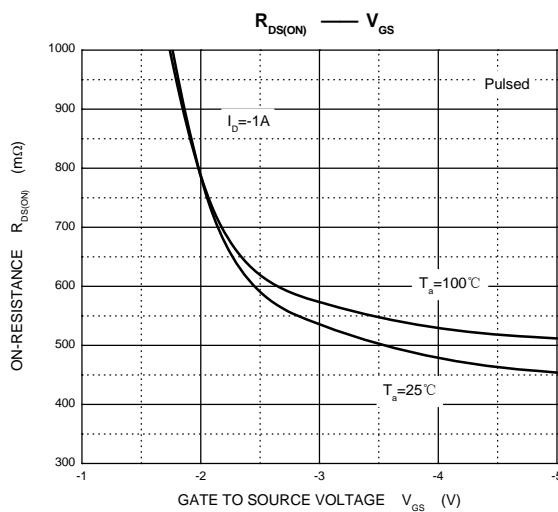
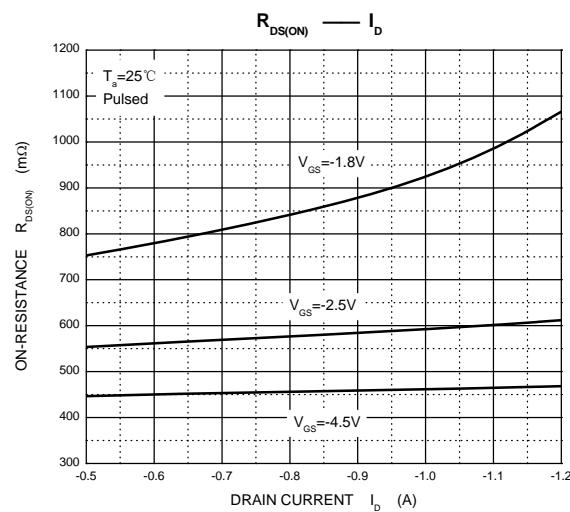
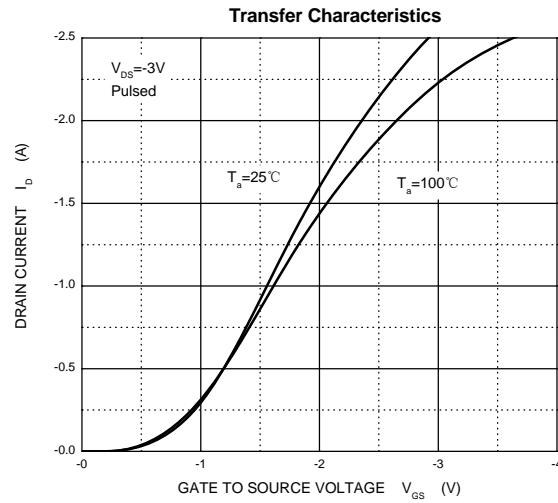
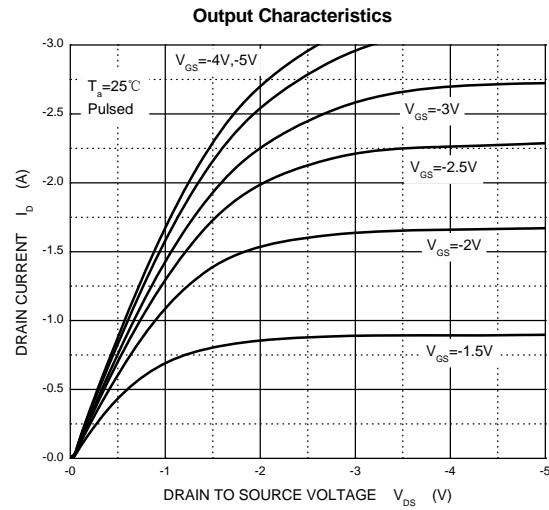
Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
<b>Static Parameters</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-20	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-20\text{V}, V_{\text{GS}}=0\text{V}$	--	--	-0.5	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=\pm 8\text{V}$	--	--	$\pm 2$	$\mu\text{A}$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-0.35	--	-1.2	V
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance <sup>B</sup>	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-0.5\text{A}$	--	560	850	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-0.3\text{A}$	--	830	1260	$\text{m}\Omega$
$V_{\text{SD}}$	Forward Voltage	$I_{\text{SD}}=-0.5\text{A}, V_{\text{GS}}=0\text{V}$	--	--	-1.2	V
<b>Dynamic and Switching Parameters <sup>C</sup></b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-16\text{V}$ $f=1\text{MHZ}$	--	152	--	pF
$C_{\text{oss}}$	Output Capacitance		--	18	--	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	6	--	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}=-16\text{V}, I_{\text{D}}=-0.2\text{A}$ $V_{\text{GS}}=-4.5\text{V}$	--	2.8	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	2.1	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	0.5	--	nC
$t_{\text{D(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=-10\text{V}$ $I_{\text{D}}=-0.2\text{A}$ , $R_{\text{GEN}}=10\Omega$ , $V_{\text{GS}}=-5\text{V}$	--	51.3	--	ns
$t_r$	Turn-on Rise Time		--	24.2	--	ns
$t_{\text{D(off)}}$	Turn-off Delay Time		--	246	--	ns
$t_f$	Turn-off Fall Time		--	81.2	--	ns

A. The data tested by surface mounted on a 1 inch x 1 inch FR-4 board with 2OZ copper.

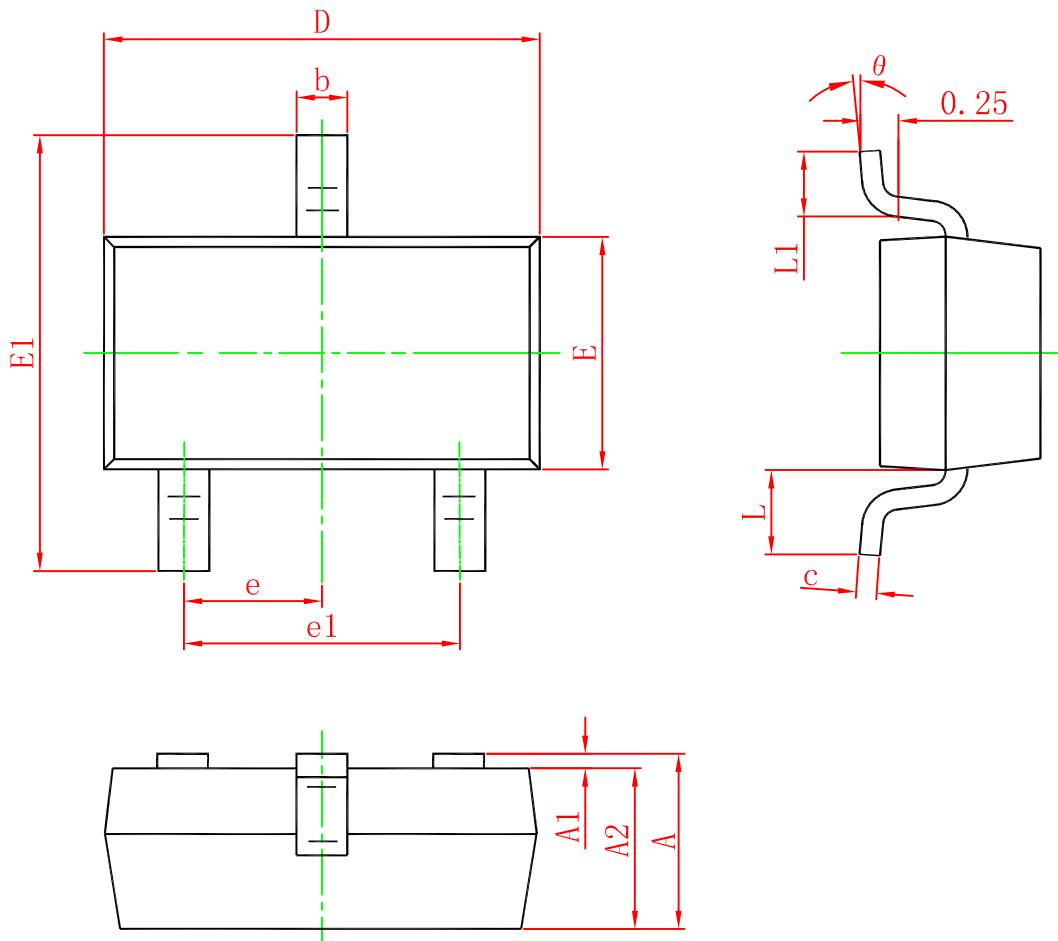
B. Pulse Test: Pulse Width  $\leq 300\text{us}$ , Duty cycle  $\leq 2\%$ .

C. Guaranteed by design, not subject to production testing.

## Typical Characteristics



## SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°